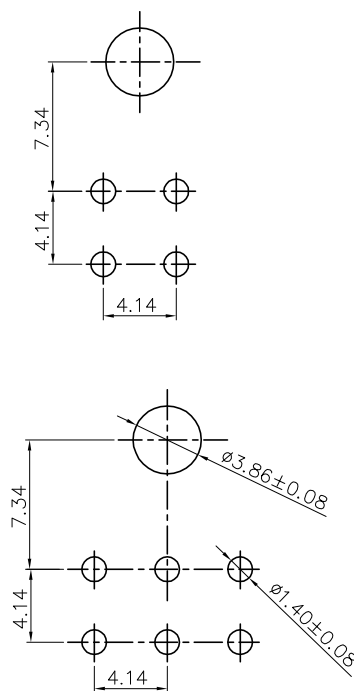
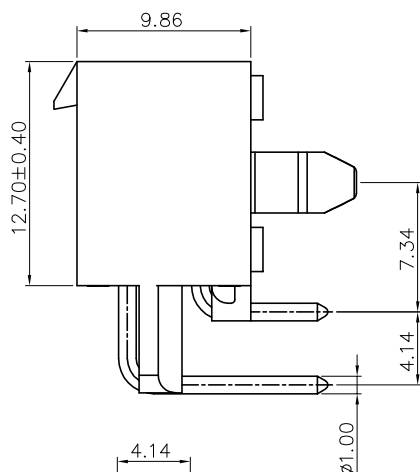
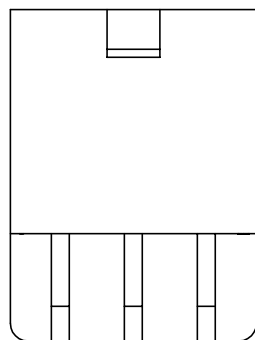
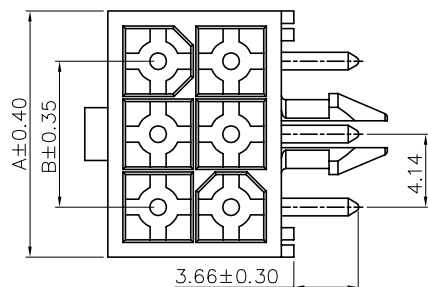
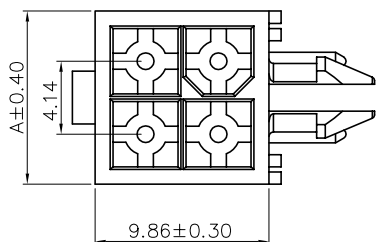


The product using material and processing must conform to the "WI-PZ-001"HSF technical standard control requirements

RoHS

2*2P

2*3P



RECOMMENDED MOUNTING HOLE PATTERN
FOR 1.57 THICK P.C. BOARD

NOTE:

1.MATERIAL SPECIFICATION:

1-1.HOUSING: PA66

1-2.CONTACTS BRASS

2.PLATING SPECIFICATION:

2-1.CONTACTS:

TIN/GOLD FLASH PLATED OVER ALL.

3.ELECTRICAL PERFORMANCE:

3-1.CURRENT RATING: 7A

RATED VOLTAGE : 600V

3-2.CONTACT RESISTANCE: 20 mΩ MAX

3-3.INSULATION RESISTANCE: 1000MΩ Min

3-4.DIELECTRIC WITHSTANDING : 1500V AC

4.ENVIRONMENTAL PERFORMANCE:

4-1.OPERATING TEMPERATURE: -25°C~+85°C.

5.PACKAGE SPEC: PE BAG

6.P/N:

SERIES NO: C4140 W 9-2 XX 1 X X X
HOUSING: 0-UL94V-0

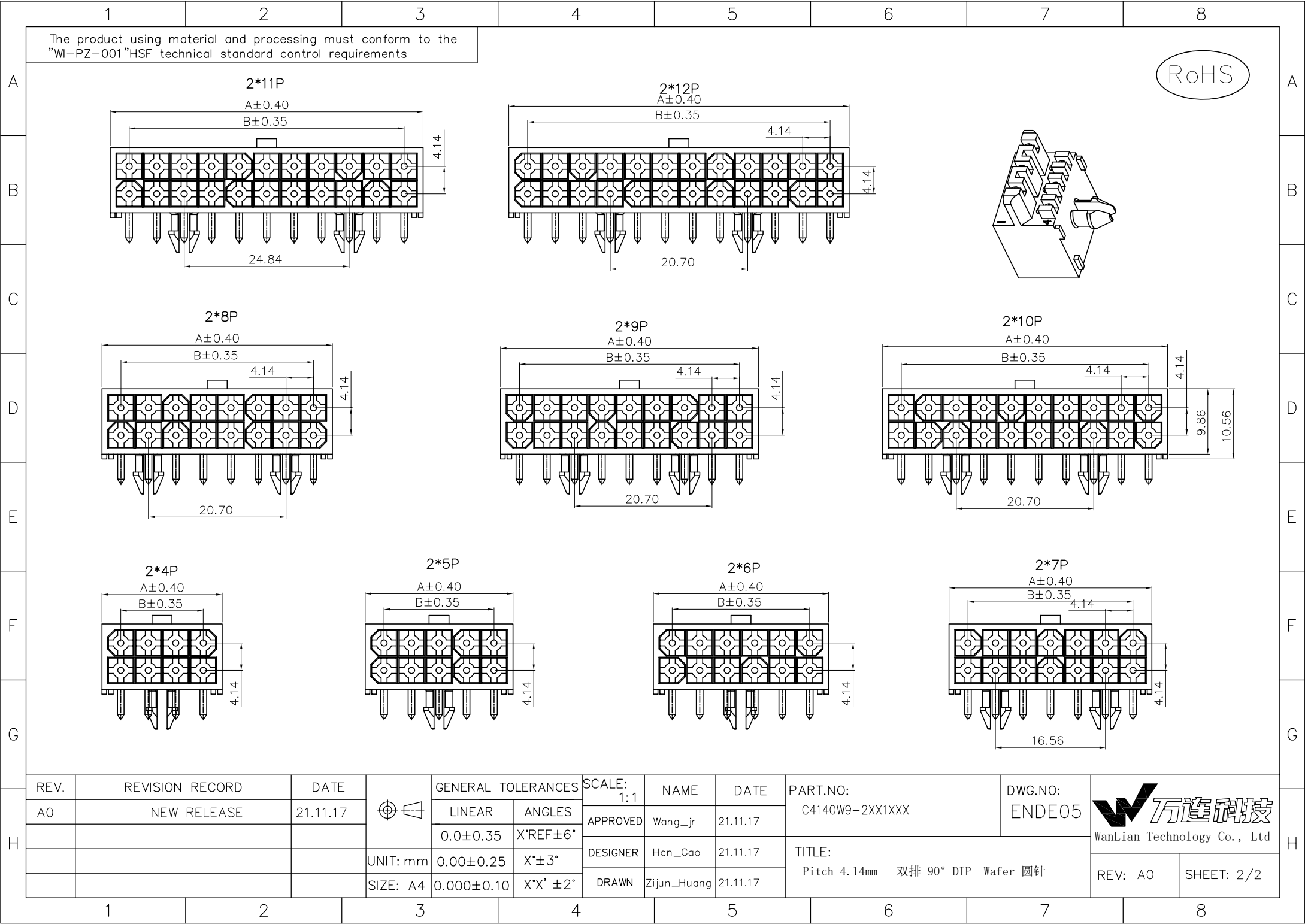
CONNECTOR: W-WAFER
COLOR: A-BLACK
S-NATURE

ANGLE: 0-180°
9-90°
ROW NO: 2-DOUBLE ROW
PLATING: C-BRIGHT TIN

PIN Q'PY: 04~24
TERMIPOINT: 1-DIP

Circuit	Dimension(mm)		Circuit	Dimension(mm)	
	A	B		A	B
2*02	9.80	---	2*08	34.80	28.98
2*03	14.00	8.28	2*09	38.94	33.12
2*04	18.14	12.42	2*10	43.20	37.26
2*05	22.28	16.56	2*11	47.32	41.40
2*06	26.42	20.70	2*12	51.50	45.54
2*07	30.56	24.84			

REV.	REVISION RECORD	DATE	UNIT: mm	GENERAL TOLERANCES		SCALE: 1:1	NAME	DATE	PART.NO:	DWG.NO:	TITLE:	REV: A0	SHEET: 1/2
				LINEAR	ANGLES								
A0	NEW RELEASE	21.11.17		0.0±0.35	X°REF±6°	APPROVED	Wang_jr	21.11.17	C4140W9-2XX1XXX	ENDE05	Pitch 4.14mm 双排 90° DIP Wafer 圆针		
				0.00±0.25	X°±3°	DESIGNER	Han_Gao	21.11.17					
				0.000±0.10	X°X° ±2°	DRAWN	Zijun_Huang	21.11.17					



REV.	REVISION RECORD	DATE		GENERAL TOLERANCES		SCALE: 1: 1	NAME	DATE	PART.NO: C4140W9-2XX1XXX	DWG.NO: ENDE05	 WanLian Technology Co., Ltd	
A0	NEW RELEASE	21.11.17		LINEAR	ANGLES	APPROVED	Wang_jr	21.11.17				
				0.0±0.35	X°REF±6°							
				UNIT: mm	0.00±0.25	X°±3°	DESIGNER	Han_Gao	21.11.17	TITLE: Pitch 4.14mm 双排 90° DIP Wafer 圆针		
			SIZE: A4	0.000±0.10	X°X' ±2°	DRAWN	Zijun_Huang	21.11.17			REV: A0	SHEET: 2/2